



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 10/763,164  
Filing Date: January 26, 2004  
Applicant: Chan-Suk LEE  
Group Art Unit: 2826  
Examiner: Alexander O. Williams  
Title: STACKED OFFSET SEMICONDUCTOR PACKAGE  
AND METHOD FOR FABRICATING (*As Amended*)  
Attorney Docket: 2557-000200/US

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Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
**Mail Stop Amendment**

March 8, 2005

**AMENDMENT UNDER 37 C.F.R. § 1.111**

Sir:

In response to the Office Action (hereinafter "Action") mailed November 8, 2005, the due date having been extended one (1) month to March 8, 2006, the following amendments and remarks are respectfully submitted in connection with the above-identified application:

**Amendments to the Claims** begin on page 2, and

**Remarks** begin on page 7 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
<b>Total</b>	22	-	22	=	0
<b>Independent</b>	5	-	5	=	0